

High power NPN epitaxial planar bipolar transistor

Features

- High breakdown voltage V_{CEO} = 80 V
- Complementary to 2STW1693
- Typical f_t = 20 MHz
- Fully characterized at 125 °C

Applications

Audio power amplifier

Description

The device is a NPN transistor manufactured in low voltage planar technology using base island layout. The resulting transistor shows good gain linearity coupled with low $V_{\text{CE(sat)}}$ behaviour. Recommended for 40 W to 70 W high fidelity audio frequency amplifier output stage.

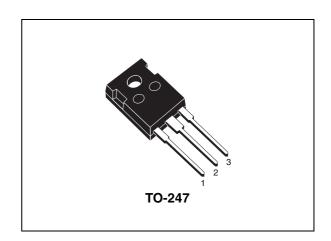


Figure 1. Internal schematic diagram

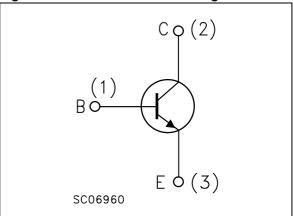


Table 1. Device summary

Order code	Marking	Package	Packaging
2STW4466	2STW4466	TO-247	Tube

Electrical ratings 2STW4466

1 Electrical ratings

Table 2. Absolute maximum rating

Symbol	Parameter	Value	Unit
V_{CBO}	Collector-base voltage (I _E = 0)	100	V
V_{CEO}	Collector-emitter voltage (I _B = 0)	80	٧
V_{EBO}	Emitter-base voltage (I _C = 0)	6	٧
I _C	Collector current	6	Α
I _{CM}	Collector peak current (t _P < 5 ms)	12	Α
P _{TOT}	Total dissipation at T _c = 25 °C	60	W
T _{stg}	Storage temperature	-65 to 150	°C
TJ	Max. operating junction temperature	150	°C

Table 3. Thermal data

Symbol	Parameter	Value	Unit
R _{thj-case}	Thermal resistance junction-case max	2.08	°C/W

2STW4466 Electrical characteristics

2 Electrical characteristics

 $(T_{case} = 25^{\circ}C; unless otherwise specified)$

Table 4. Electrical characteristics

Symbol	Parameter	Test cor	nditions	Min.	Тур.	Max.	Unit
I _{CBO}	Collector cut-off current (I _E = 0)	V _{CB} = 100 V				0.1	μΑ
I _{EBO}	Emitter cut-off current (I _C = 0)	V _{EB} = 6 V				0.1	μΑ
V _{(BR)EBO}	Emitter-base breakdown voltage (I _C = 0)	I _E = 1 mA		6			V
V _{(BR)CBO}	Collector-base breakdown voltage (I _E = 0)	I _C = 100 μA		100			V
V _{(BR)CEO}	Collector-emitter breakdown voltage (I _B = 0)	I _C = 50 mA		80			V
V _{CE(sat)} (1)	Collector-emitter saturation voltage	$I_C = 2$ $I_C = 6 A$	$I_B = 200 \text{ mA}$ $I_B = 600 \text{ mA}$			0.6 1.5	V V
V _{BE} (1)	Base-emitter voltage	V _{CE} = 4 V	I _C = 6 A			1.5	V
h _{FE}	DC current gain	I _C = 2 A	V _{CE} = 4 V	50		120	
f _T	Transition frequency	I _C = 0.5 A	V _{CE} = 12 V		20		MHz
C _{CBO}	Collector-base capacitance (I _E = 0)	V _{CB} = 10 V	f = 1 MHz		50		pF
	Resistive load						
t _{on}	Turn-on time	I _C = 3 A	$V_{CC} = 30 \text{ V}$		0.15		ns
t _{stg}	Storage time	$I_{B1} = -I_{B2} = 0.3 \text{ A}$			1.5		ns
t _f	Fall time				0.1		ns

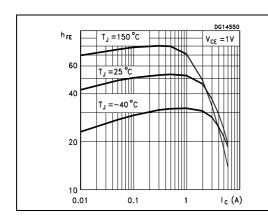
Pulsed duration = 300 $\mu s,$ duty cycle $\leq 1.5\%$

Electrical characteristics 2STW4466

2.1 Electrical characteristics (curves)

Figure 2. DC current gain

Figure 3. DC current gain



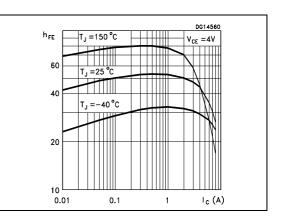
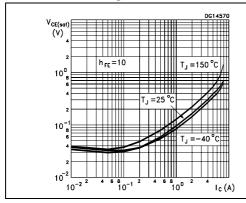


Figure 4. Collector-emitter saturation voltage

Figure 5. Base-emitter saturation voltage



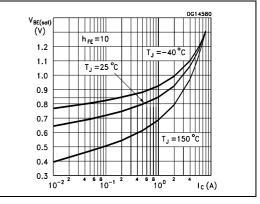
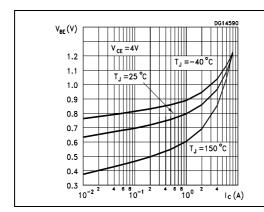
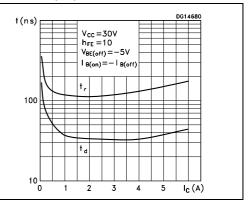


Figure 6. Base emitter voltage

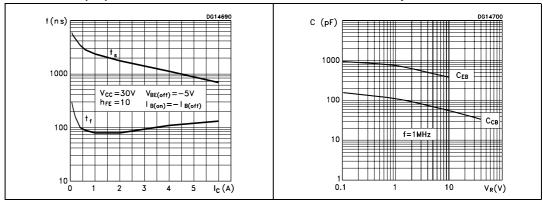
Figure 7. Resistive load switching time (on)





2STW4466 Electrical characteristics

Figure 8. Resistive load switching time Figure 9. Emitter-base and collector-base capacitance

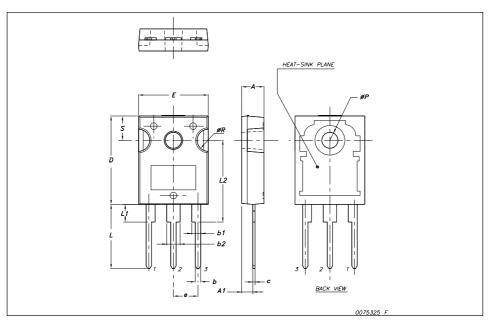


3 Package mechanical data

In order to meet environmental requirements, ST offers these devices in ECOPACK® packages. These packages have a Lead-free second level interconnect . The category of second level interconnect is marked on the package and on the inner box label, in compliance with JEDEC Standard JESD97. The maximum ratings related to soldering conditions are also marked on the inner box label. ECOPACK is an ST trademark. ECOPACK specifications are available at: www.st.com

TO-247 Mechanical data

Dim.	mm.				
	Min.	Тур	Max.		
Α	4.85		5.15		
A1	2.20		2.60		
b	1.0		1.40		
b1	2.0		2.40		
b2	3.0		3.40		
С	0.40		0.80		
D	19.85		20.15		
Е	15.45		15.75		
е		5.45			
L	14.20		14.80		
L1	3.70		4.30		
L2		18.50			
øΡ	3.55		3.65		
øR	4.50		5.50		
S		5.50			



Revision history 2STW4466

4 Revision history

Table 5. Document revision history

Date	Revision	Changes	
11-Oct-2007	1	First release	
25-Sep-2008	2	Content reworked to improve readability, no technical changes.	

Please Read Carefully:

Information in this document is provided solely in connection with ST products. STMicroelectronics NV and its subsidiaries ("ST") reserve the right to make changes, corrections, modifications or improvements, to this document, and the products and services described herein at any time, without notice.

All ST products are sold pursuant to ST's terms and conditions of sale.

Purchasers are solely responsible for the choice, selection and use of the ST products and services described herein, and ST assumes no liability whatsoever relating to the choice, selection or use of the ST products and services described herein.

No license, express or implied, by estoppel or otherwise, to any intellectual property rights is granted under this document. If any part of this document refers to any third party products or services it shall not be deemed a license grant by ST for the use of such third party products or services, or any intellectual property contained therein or considered as a warranty covering the use in any manner whatsoever of such third party products or services or any intellectual property contained therein.

UNLESS OTHERWISE SET FORTH IN ST'S TERMS AND CONDITIONS OF SALE ST DISCLAIMS ANY EXPRESS OR IMPLIED WARRANTY WITH RESPECT TO THE USE AND/OR SALE OF ST PRODUCTS INCLUDING WITHOUT LIMITATION IMPLIED WARRANTIES OF MERCHANTABILITY, FITNESS FOR A PARTICULAR PURPOSE (AND THEIR EQUIVALENTS UNDER THE LAWS OF ANY JURISDICTION), OR INFRINGEMENT OF ANY PATENT, COPYRIGHT OR OTHER INTELLECTUAL PROPERTY RIGHT.

UNLESS EXPRESSLY APPROVED IN WRITING BY AN AUTHORIZE REPRESENTATIVE OF ST, ST PRODUCTS ARE NOT RECOMMENDED, AUTHORIZED OR WARRANTED FOR USE IN MILITARY, AIR CRAFT, SPACE, LIFE SAVING, OR LIFE SUSTAINING APPLICATIONS, NOR IN PRODUCTS OR SYSTEMS, WHERE FAILURE OR MALFUNCTION MAY RESULT IN PERSONAL INJURY, DEATH, OR SEVERE PROPERTY OR ENVIRONMENTAL DAMAGE. ST PRODUCTS WHICH ARE NOT SPECIFIED AS "AUTOMOTIVE GRADE" MAY ONLY BE USED IN AUTOMOTIVE APPLICATIONS AT USER'S OWN RISK.

Resale of ST products with provisions different from the statements and/or technical features set forth in this document shall immediately void any warranty granted by ST for the ST product or service described herein and shall not create or extend in any manner whatsoever, any liability of ST.

ST and the ST logo are trademarks or registered trademarks of ST in various countries.

Information in this document supersedes and replaces all information previously supplied.

The ST logo is a registered trademark of STMicroelectronics. All other names are the property of their respective owners.

© 2008 STMicroelectronics - All rights reserved

STMicroelectronics group of companies

Australia - Belgium - Brazil - Canada - China - Czech Republic - Finland - France - Germany - Hong Kong - India - Israel - Italy - Japan - Malaysia - Malta - Morocco - Singapore - Spain - Sweden - Switzerland - United Kingdom - United States of America

www.st.com

